

FM400TU-2AHIGH POWER SWITCHING USE
INSULATED PACKAGE**FM400TU-2A**

- ID(rms) 200A
- VDSS 100V
- Insulated Type
- 6-elements in a pack
- Thermistor inside
- UL Recognized

Yellow Card No.E80276

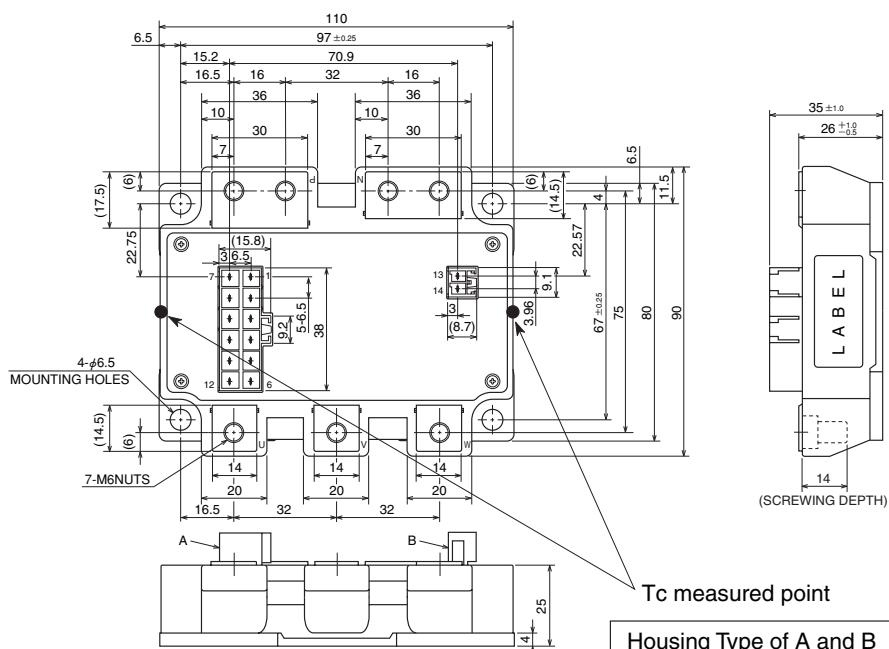
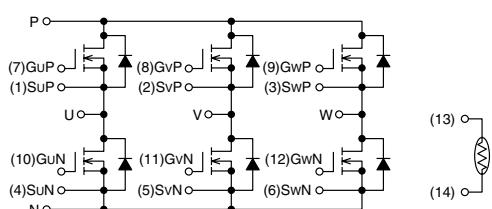
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APPLICATION

AC motor control of forklift (battery power source), UPS

OUTLINE DRAWING & CIRCUIT DIAGRAM

Dimensions in mm

**CIRCUIT DIAGRAM**Housing Type of A and B
(Tyco Electronics P/N:)

A: 917353-1

B: 179838-1

(1) SUP	(2) SvP	(3) SwP	(4) SuN	(5) SvN	(6) SwN	A
(7) GuP	(8) GvP	(9) GwP	(10) GuN	(11) GvN	(12) GwN	B
(13) TH1	(14) TH2					

FM400TU-2A

**HIGH POWER SWITCHING USE
INSULATED PACKAGE**

ABSOLUTE MAXIMUM RATINGS (T_{ch} = 25°C unless otherwise specified.)

Symbol	Item	Conditions	Ratings	Unit
V _{DSS}	Drain-source voltage	G-S Short	100	V
V _{GSS}	Gate-source voltage	D-S Short	±20	V
I _D	Drain current	T _{C'} = 130°C* ³	200	A
I _{DM}		Pulse* ²	400	A
I _{DA}	Avalanche current	L = 10μH Pulse* ²	200	A
I _{S*} ¹			200	A
I _{SM*} ¹	Source current	Pulse* ²	400	A
P _{D*} ⁴	Maximum power dissipation	T _C = 25°C	650	W
P _{D*} ⁴		T _{C'} = 25°C* ³	880	W
T _{ch}	Channel temperature		-40 ~ +150	°C
T _{stg}	Storage temperature		-40 ~ +125	°C
V _{iso}	Isolation voltage	Main terminal to base plate, AC 1 min.	2500	V
—	Mounting torque	Main Terminal M6	3.5 ~ 4.5	N·m
—		Mounting M6	3.5 ~ 4.5	N·m
—	Weight	Typical value	600	g

ELECTRICAL CHARACTERISTICS (T_{ch} = 25°C unless otherwise specified.)

Symbol	Item	Conditions	Limits			Unit
			Min.	Typ.	Max.	
I _{DSS}	Drain cutoff current	V _D = V _{DSS} , V _G = 0V	—	—	1	mA
V _{G(S)th}	Gate-source threshold voltage	I _D = 20mA, V _D = 10V	4.7	6	7.3	V
I _{GSS}	Gate leakage current	V _G = V _{GSS} , V _D = 0V	—	—	1.5	μA
r _{D(on)} (chip)	Static drain-source On-state resistance	I _D = 200A V _G = 15V	T _{ch} = 25°C T _{ch} = 125°C	— —	1.45 2.5	2.0 —
V _{D(on)} (chip)	Static drain-source On-state voltage	I _D = 200A V _G = 15V	T _{ch} = 25°C T _{ch} = 125°C	— —	0.29 0.50	0.40 —
R _(lead)	Lead resistance	I _D = 200A terminal-chip	T _{ch} = 25°C T _{ch} = 125°C	— —	0.8 1.12	— —
C _{iss}	Input capacitance	V _D = 10V V _G = 0V		—	—	75
C _{oss}	Output capacitance			—	—	10
C _{rss}	Reverse transfer capacitance			—	—	6
Q _G	Total gate charge	V _D = 48V, I _D = 200A, V _G = 15V	—	1200	—	nC
t _{d(on)}	Turn-on delay time	V _D = 48V, I _D = 200A, V _{G1} = V _{G2} = 15V RG = 6.3Ω, Inductive load switching operation IS = 200A		—	—	400
t _r	Turn-on rise time			—	—	400
t _{d(off)}	Turn-off delay time			—	—	450
t _f	Turn-off fall time			—	—	300
t _{rr*} ¹	Reverse recovery time			—	—	250
Q _{rr*} ¹	Reverse recovery charge			—	6.0	—
V _{SD*} ¹	Source-drain voltage	I _S = 200A, V _G = 0V	—	—	1.3	V
R _{th(ch-c)}	Thermal resistance	MOSFET part (1/6 module)* ⁷	—	—	0.19	°C/W
R _{th(ch-c')}		MOSFET part (1/6 module)* ³	—	—	0.142	
R _{th(c-f)}	Contact thermal resistance	Case to fin, Thermal grease Applied* ⁸ (1/6 module)	—	0.1	—	
R _{th(c'-f')}		Case to fin, Thermal grease Applied* ^{3, 8} (1/6 module)	—	0.09	—	

THERMISTOR PART

Symbol	Parameter	Conditions	Limits			Unit
			Min.	Typ.	Max.	
R _{TH*} ⁶	Resistance	T _{TH} = 25°C* ⁵	—	100	—	kΩ
B ⁶	B Constant	Resistance at T _{TH} = 25°C, 50°C* ⁵	—	4000	—	K

*1: It is characteristics of the anti-parallel, source to drain free-wheel diode (FWDi).

*2: Pulse width and repetition rate should be such that the device channel temperature (T_{ch}) does not exceed T_{ch} max rating.

*3: T_{C'} measured point is just under the chips. If use this value, R_{th(f-a)} should be measured just under the chips.

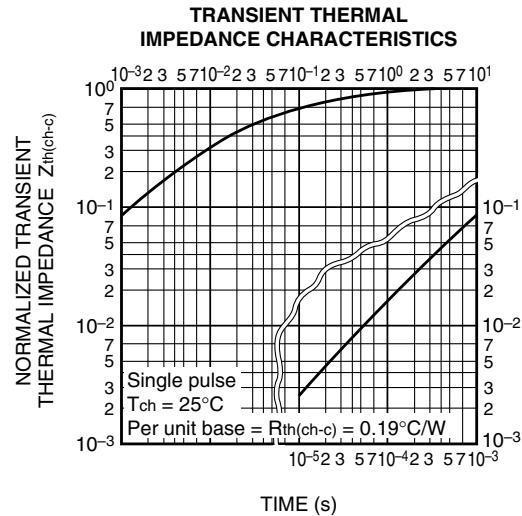
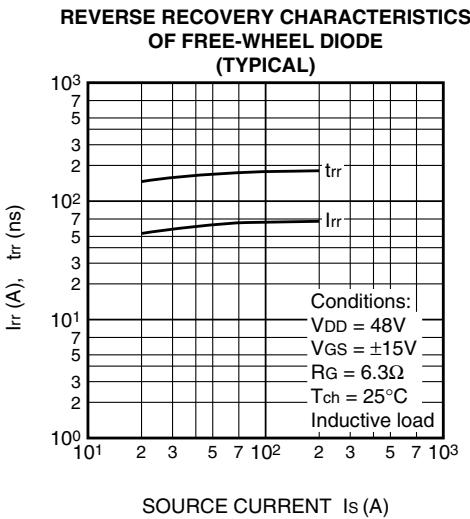
*4: Pulse width and repetition rate should be such as to cause negligible temperature rise.

*5: T_{TH} is thermistor temperature.

*6: B = (lnR₁-lnR₂)/(1/T₁-1/T₂) R₁: Resistance at T₁(K), R₂: Resistance at T₂(K)

*7: T_C measured point is shown in page OUTLINE DRAWING.

*8: Typical value is measured by using Shin-Etsu Chemical Co., Ltd "G-746".

**CHIP LAYOUT**